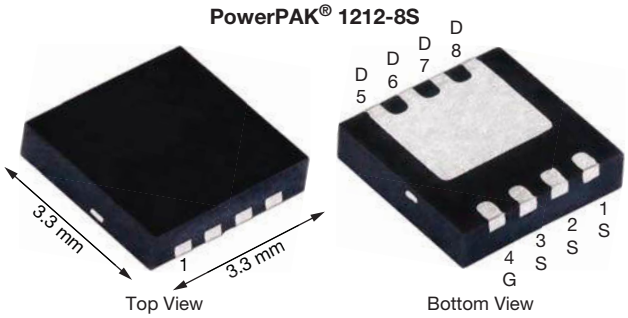
P-Channel 100 V (D-S) MOSFET

PRODUCT SUMMARY			
V_{DS} (V)	$R_{DS(on)}$ (Ω) (MAX.)	I_D (A) [e]	Q_g (TYP.)
-100	0.059 at V_{GS} = -10 V	-23	20 nC
	0.082 at V_{GS} = -4.5 V	-19.6	

PowerPAK® 1212-8S



Top View Bottom View

Ordering Information:
SiSS71DN-T1-GE3 (lead (Pb)-free and halogen-free)

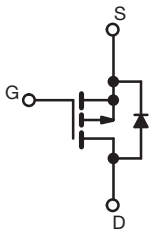
FEATURES

- ThunderFET® power MOSFET
- Low thermal resistance PowerPAK® package with small size and low 0.75 mm profile
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

APPLICATIONS

- Active clamp
- DC/DC converters
- POE
- Load switch
- Motor drive control
- Battery management



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V_{DS}	-100	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current (T_J = 150 °C)	T_C = 25 °C	I_D	-23	A
	T_C = 70 °C		-18.5	
	T_A = 25 °C		-6.7 [a, b]	
	T_A = 70 °C		-5.4 [a, b]	
Pulsed Drain Current (t = 100 µs)		I_{DM}	-40	
Continuous Source-Drain Diode Current	T_C = 25 °C	I_S	-40 [e]	
	T_A = 25 °C		-4 [a, b]	
Avalanche Current	L = 0.1 mH	I_{AS}	-25	
Single Pulse Avalanche Energy		E_{AS}	31	mJ
Maximum Power Dissipation	T_C = 25 °C	P_D	57	W
	T_C = 70 °C		36	
	T_A = 25 °C		4.8 [a, b]	
	T_A = 70 °C		3 [a, b]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	-50 to +150	°C
Soldering Recommendations (Peak temperature) [c, d]			260	

Notes

a. Surface mounted on 1" x 1" FR4 board.
b. t = 10 s.
c. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8S is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
e. T_C = 25 °C.

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient [a, b]	t ≤ 10 s	R_{thJA}	21	26	°C/W
Maximum Junction-to-Case (Drain)	Steady state	R_{thJC}	1.7	2.2	

Notes

a. Surface mounted on 1" x 1" FR4 board.
b. Maximum under steady state conditions is 63 °C/W.

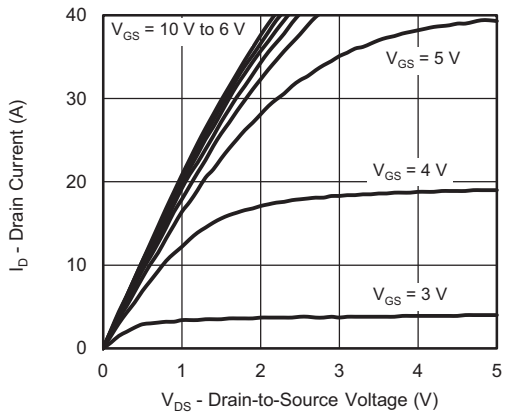
SPECIFICATIONS (T_J = 25 °C, unless otherwise noted)						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Static						
Drain-Source Breakdown Voltage	V_{DS}	V_{GS} = 0 V, I_D = -250 µA	-100	-	-	V
V_{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	I_D = -250 µA	-	-56	-	mV/°C
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$		-	4.2	-	
Gate-Source Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = -250 µA	-1.5	-	-2.5	V
Gate-Source Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = -100 V, V_{GS} = 0 V	-	-	-1	µA
		V_{DS} = -5 V, V_{GS} = 0 V, T_J = 55 °C	-	-	-10	
On-State Drain Current [a]	$I_{D(on)}$	$V_{DS} \leq$ -5 V, V_{GS} = -10 V	-5	-	-	A
Drain-Source On-State Resistance [a]	$R_{DS(on)}$	V_{GS} = -10 V, I_D = -5 A	-	0.047	0.059	Ω
		V_{GS} = -4.5 V, I_D = -5 A	-	0.063	0.082	
Forward Transconductance [a]	g_{fs}	V_{DS} = -15 V, I_D = -5 A	-	13	-	S
Dynamic [b]						
Input Capacitance	C_{iss}	V_{DS} = -50 V, V_{GS} = 0 V, f = 1 MHz	-	1050	-	pF
Output Capacitance	C_{oss}		-	330	-	
Reverse Transfer Capacitance	C_{rss}		-	20	-	
Total Gate Charge	Q_g	V_{DS} = -50 V, V_{GS} = -10 V, I_D = -10 A	-	20	30	nC
		V_{DS} = -50 V, V_{GS} = -4.5 V, I_D = -10 A	-	10	15	
Gate-Source Charge	Q_{gs}		-	3.4	-	
Gate-Drain Charge	Q_{gd}		-	4.4	-	
Gate Resistance	R_g	f = 1 MHz	1.1	5.7	11.4	Ω
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = -50 V, R_L = 10 Ω, $I_D \cong$ -5 A, V_{GEN} = -4.5 V, R_g = 1 Ω	-	35	70	ns
Rise Time	t_r		-	30	60	
Turn-Off Delay Time	$t_{d(off)}$		-	21	40	
Fall Time	t_f		-	11	20	
Turn-On Delay Time	$t_{d(on)}$	V_{DD} = -50 V, R_L = 10 Ω, $I_D \cong$ -5 A, V_{GEN} = -10 V, R_g = 1 Ω	-	10	20	
Rise Time	t_r		-	18	40	
Turn-Off Delay Time	$t_{d(off)}$		-	25	50	
Fall Time	t_f		-	11	20	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I_S	T_C = 25 °C	-	-	-40 [c]	A
Pulse Diode Forward Current [a]	I_{SM}		-	-	-40	
Body Diode Voltage	V_{SD}	I_F = -5 A	-	-0.83	-1.2	V
Body Diode Reverse Recovery Time	t_{rr}	I_F = -5 A, dI/dt = 100 A/µs, T_J = 25 °C	-	65	130	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	156	312	nC
Reverse Recovery Fall Time	t_a		-	37	-	ns
Reverse Recovery Rise Time	t_b		-	28	-	

Notes

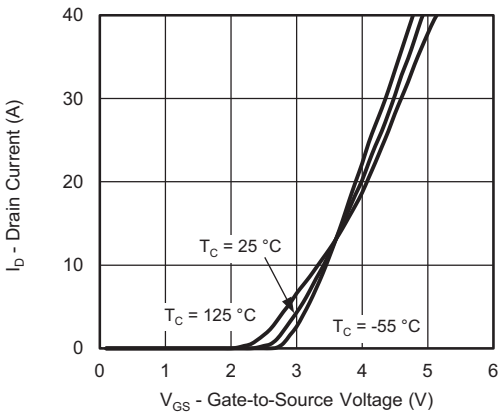
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.
c. Package limited.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

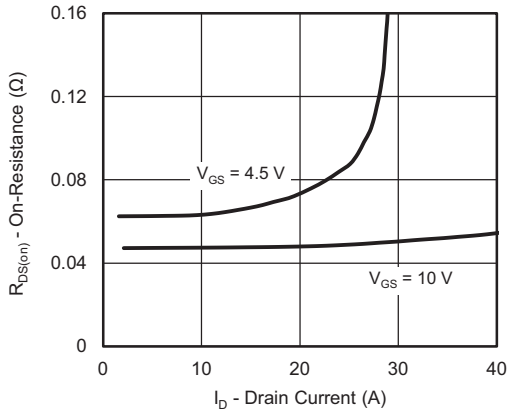
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



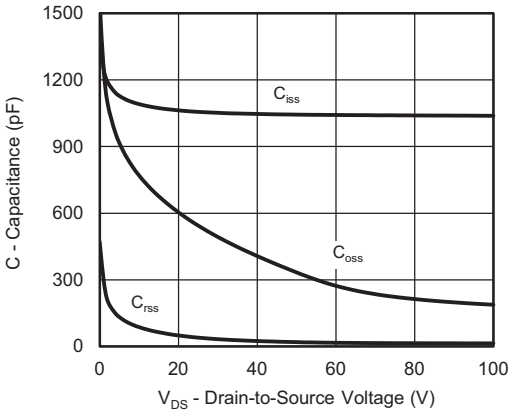
Output Characteristics



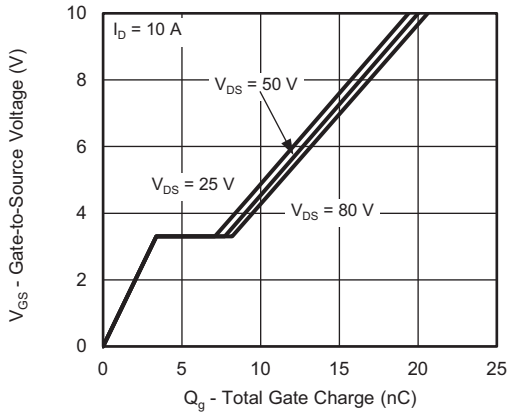
Transfer Characteristics



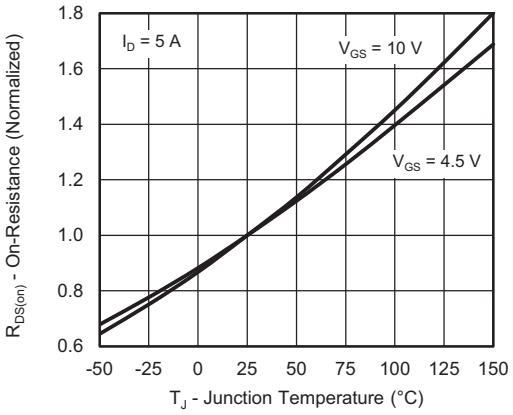
On-Resistance vs. Drain Current and Gate Voltage



Capacitance

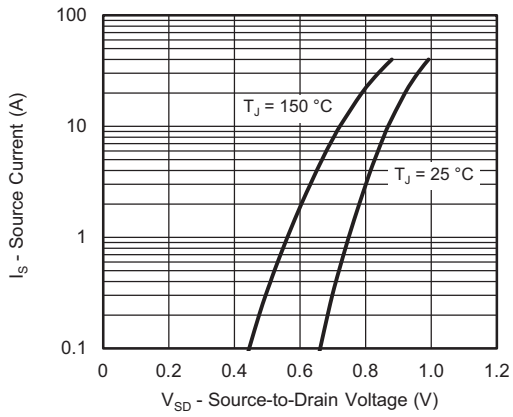


Gate Charge

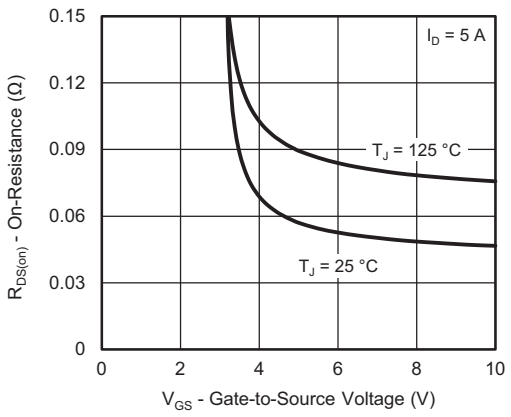


On-Resistance vs. Junction Temperature

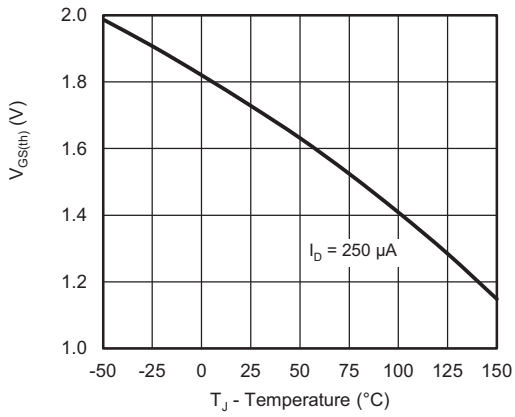
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



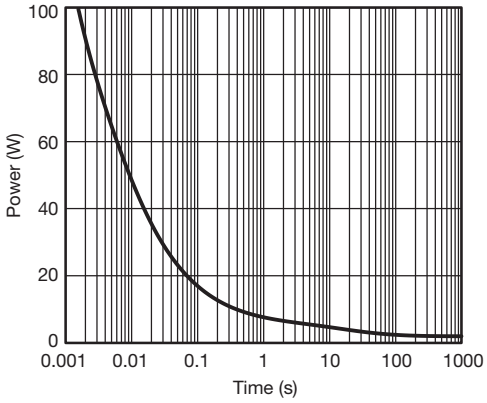
Source-Drain Diode Forward Voltage



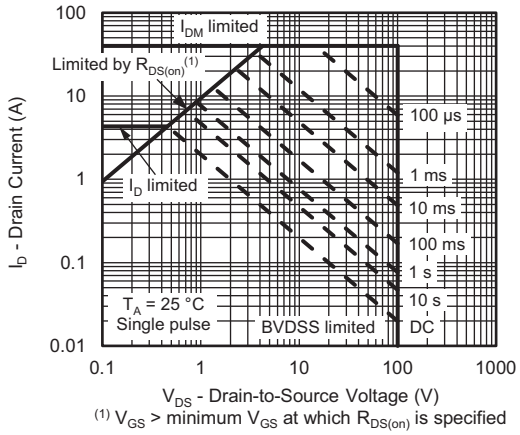
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

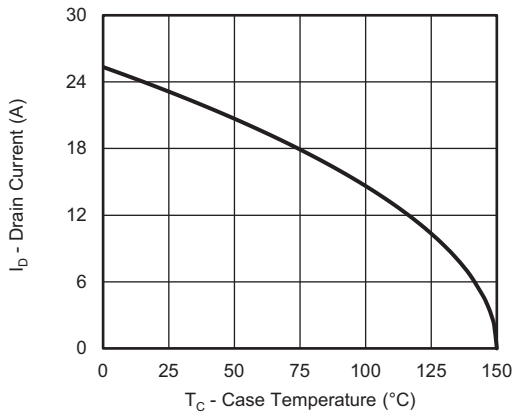


Single Pulse Power, Junction-to-Ambient

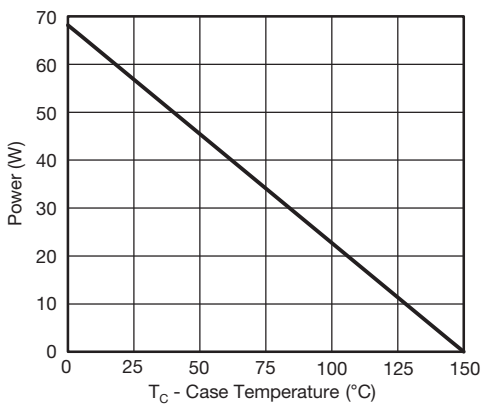


Safe Operating Area, Junction-to-Ambient

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating [a]

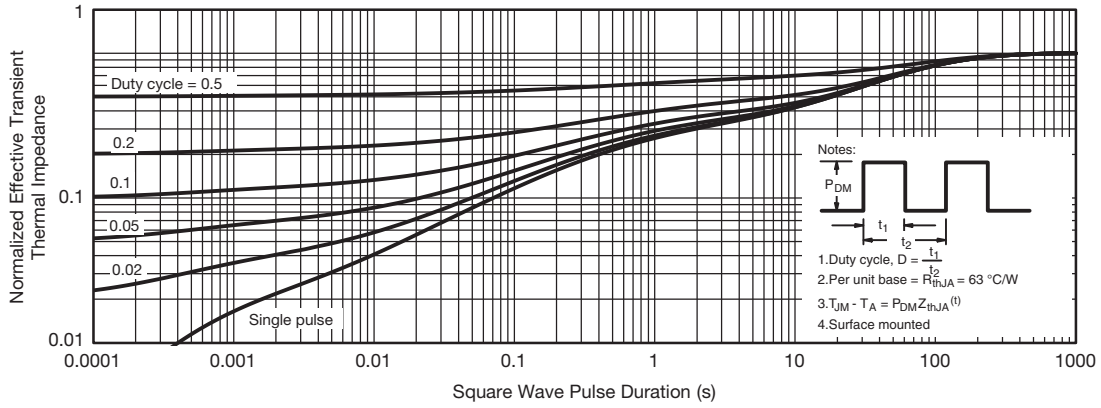


Power, Junction-to-Case

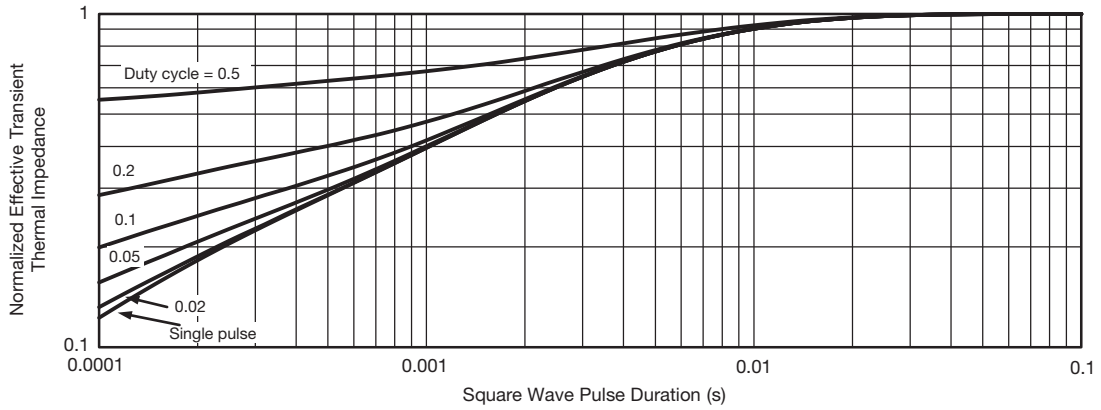
Note

a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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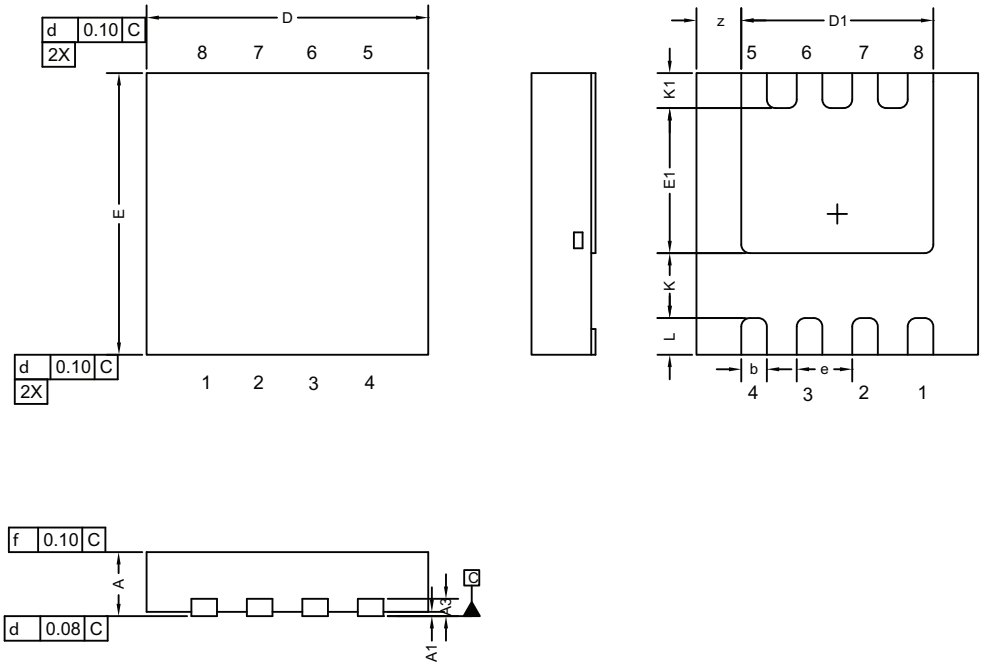
Case Outline for PowerPAK® 1212-8S

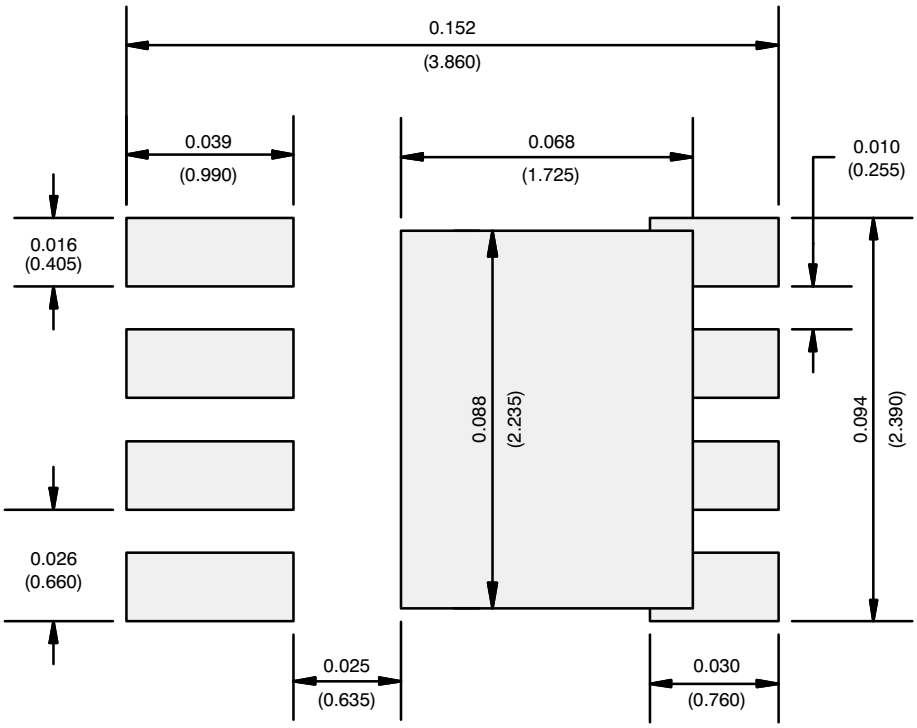


DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.67	0.75	0.83	0.027	0.030	0.033
A1	0	-	0.05	0	-	0.002
A3	0.20 REF			0.008 REF		
b	0.30 BSC			0.012 BSC		
D	3.30 BSC			0.130 BSC		
D1	2.15	2.25	2.35	0.084	0.088	0.092
E	3.30 BSC			0.130 BSC		
E1	1.60	1.70	1.80	0.063	0.067	0.071
e	0.65 BSC			0.026 BSC		
K	0.76 TYP			0.030 TYP		
K1	0.41 TYP			0.016 TYP		
L	0.43 BSC			0.017 BSC		
z	0.525 TYP			0.021 TYP		
ECN: C12-0200-Rev. A, 12-Mar-12 DWG: 6008						

Note

- Millimeters will govern.

RECOMMENDED MINIMUM PADS FOR PowerPAK® 1212-8 Single



Recommended Minimum Pads
Dimensions in Inches/(mm)

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